

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
30V	$20m\Omega$ @ $V_{GS} = 10V$	18.4A
30 V	30mΩ @ V _{GS} = 4.5V	15.0A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- DC-DC Converters
- Power Management Functions

Features

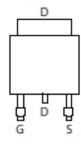
- Low R_{DS(ON)} Ensures on State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

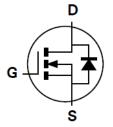
- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Weight: 0.33 grams (approximate)



Top View



Pin Out Top View



Equivalent Circuit

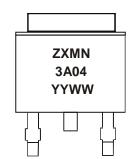
Ordering Information (Note 4)

Part Number	Case	Packaging
ZXMN3A04KTC	TO252	2500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZXMN3A04 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 14 = 2014) WW = Week Code (01 to 53)



Maximum Ratings $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

Characteris	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current V _{GS} = 10V	Steady State	$T_A = +25$ °C (Note 5) $T_A = +70$ °C (Note 5) $T_A = +25$ °C (Note 6)	l _D	18.4 14.7 12.0	А
Pulsed Drain Current (Note 7)	I _{DM}	66	Α		
Continuous Source Current (Body Diode) (Note 5)	Is	11.5	Α		
Pulsed Source Current (Body Diode) (Note 7)	I _{SM}	66	А		

Thermal Characteristics

Characteristic	Symbol	Value	Units
Power Dissipation at T _A = +25°C (Note 6) Linear Derating Factor	P _D	4.3 34.4	W mW/°C
Power Dissipation at T _A = +25°C (Note 5) Linear Derating Factor	P _D	10.1 80.8	W mW/°C
Power Dissipation at T _A = +25°C (Note 8) Linear Derating Factor	P _D	2.15 17.2	W mW/°C
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	29	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	12.3	°C/W
Thermal Resistance, Junction to Ambient (Note 8)	$R_{\theta JA}$	58	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	-	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS							
Gate Threshold Voltage	$V_{GS(th)}$	1.0	_	-	V	$V_{DS} = V_{GS}$, $I_D = 250 \text{mA}$	
Static Drain-Source On-Resistance (Note 9)	7	_	_	20	mΩ	$V_{GS} = 10V, I_D = 12A$	
Static Dialii-Source Off-Resistance (Note 9)	R _{DS(ON)}	_	_	30	11122	$V_{GS} = 4.5V, I_D = 9.8A$	
Diode Forward Voltage (Note 9)	V _{SD}	_	0.85	0.95	V	$T_J = +25$ °C, $I_S = 6.8$ A,	
<u> </u>	V 2D			0.00	•	$V_{GS} = 0V$	
Forward Transconductance (Notes 9 & 11)	g _{fs}	_	22.1	_	S	$V_{DS} = 15V, I_D = 12.6A$	
DYNAMIC CHARACTERISTICS (Notes 10 & 11)							
Input Capacitance	C _{iss}		1890	_		$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	349	-	pF		
Reverse Transfer Capacitance	C _{rss}	_	218				
Total Gate Charge (V _{GS} = 5V)	Q_g	_	19.9	-		V _{DS} = 15V, I _D = 6.5A	
Total Gate Charge (V _{GS} = 10V)	Q_g	_	36.8	_	nC		
Gate-Source Charge	Q _{gs}	_	5.8	_	iiC		
Gate-Drain Charge	Q_{gd}	_	7.1	-			
Turn-On Delay Time	t _{D(ON)}	_	5.2	_		$V_{DS} = 15V$, $V_{GS} = 10V$, $I_{D} = 1A$, $R_{GEN} = 6\Omega$	
Turn-On Rise Time	t _R	_	6.1	_	20		
Turn-Off Delay Time	t _{D(OFF)}	_	38.1	-	ns		
Turn-Off Fall Time	t _F	_	20.2	_			
Reverse Recovery Time	t _{RR}	_	18.4	_	ns	1 2 2 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	
Reverse Recovery Charge	Q _{RR}	_	11	_	nC	$I_S = 2.3A$, di/dt = 100A/ μ s	

Notes: 5. For a device surface mounted on FR4 PCB measured at \leq 10 sec.

- 6. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
- 7. Repetitive rating 50mm x 50mm x 1.6mm FR4 PCB, D=0.02 pulse width=300µs pulse width limited by maximum junction temperature.
- 8. For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
- 9. Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.
- 10. Switching characteristics are independent of operating junction temperature.
- 11. For design aid only, not subject to production testing.



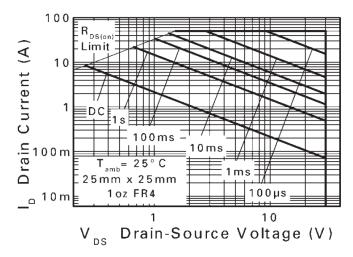


Figure 1. Safe Operating Area

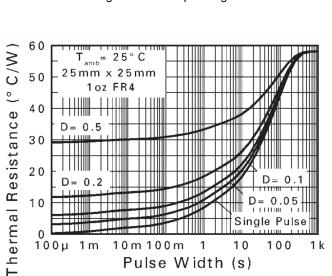


Figure 3. Transient Thermal Impedance

Pulse Width (s)

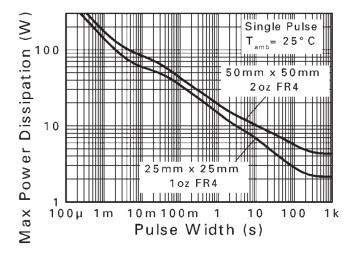


Figure 5. Pulse Power Dissipation

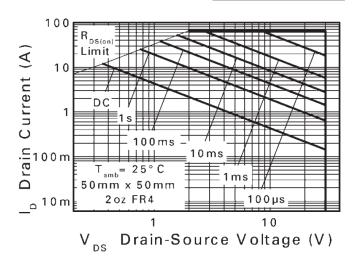


Figure 2. Safe Operating Area

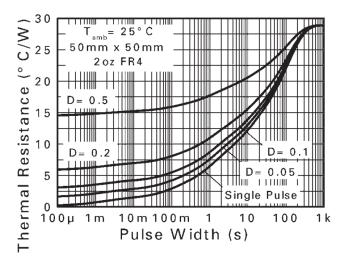


Figure 4. Transient Thermal Impedance

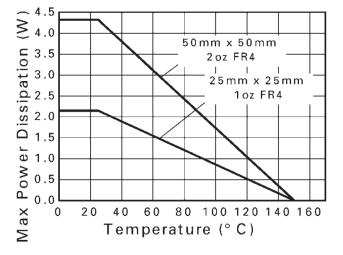


Figure 6. Derating Curve



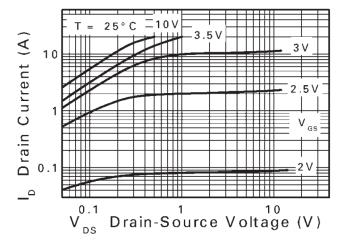


Figure 7. Output Characteristics

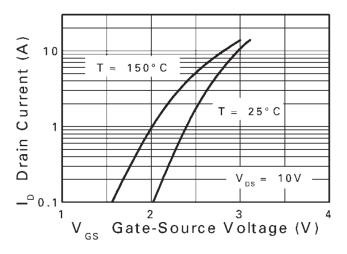


Figure 9. Typical Transfer Characteristics

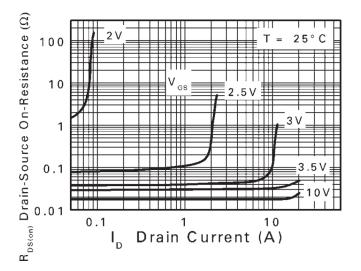


Figure 11. On-Resistance vs. Drain Current

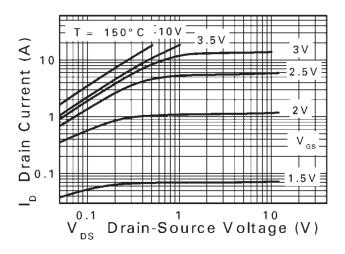


Figure 8. Output Characteristics

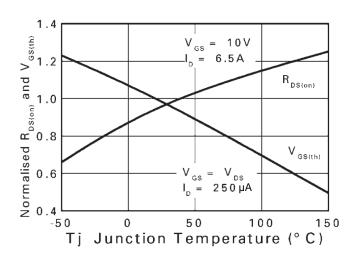


Figure 10. Normalised Curves vs. Temperature

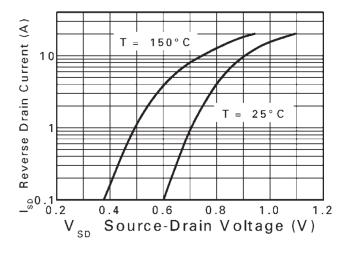


Figure 12. Source-Drain Diode Forward Voltage



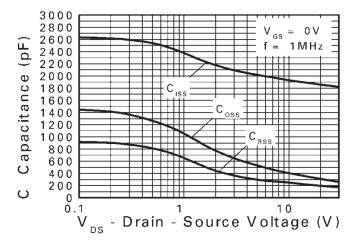


Figure 13. Capacitance vs. Drain-Source Voltage

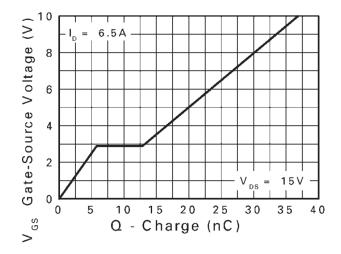
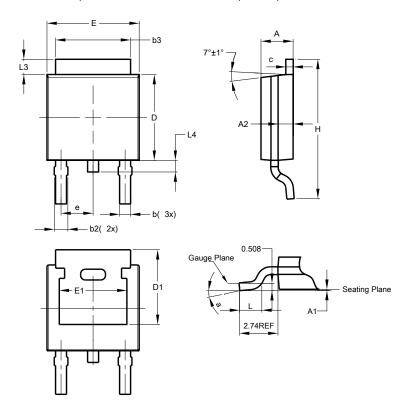


Figure 14. Gate-Source Voltage vs. Gate Charge



Package Outline Dimensions

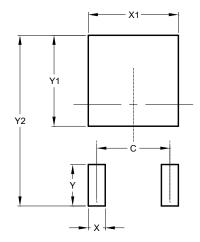
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	TO252 (DPAK)					
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Ε	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
C	4.572			
Х	1.060			
X1	5.632			
Y	2.600			
Y1	5.700			
Y2	10.700			



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